

The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements



A

B

C

D

E

F

G

H

A

B

C

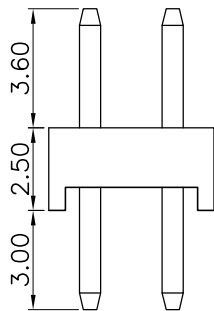
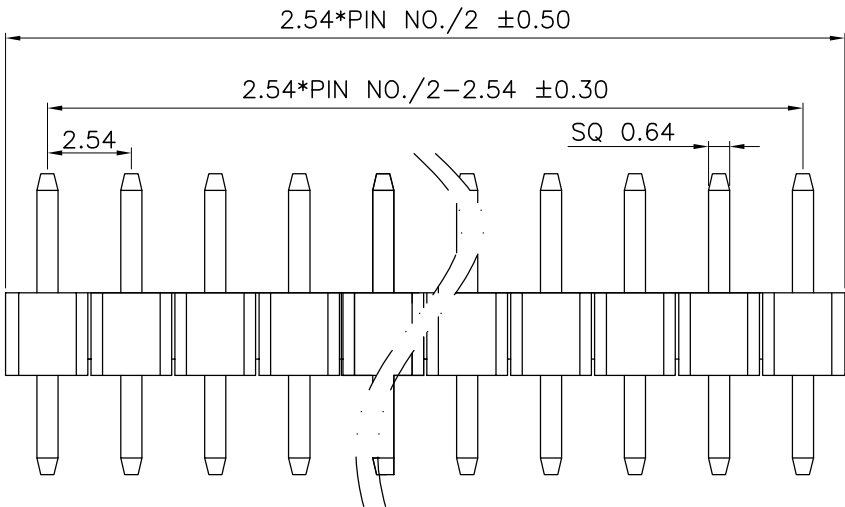
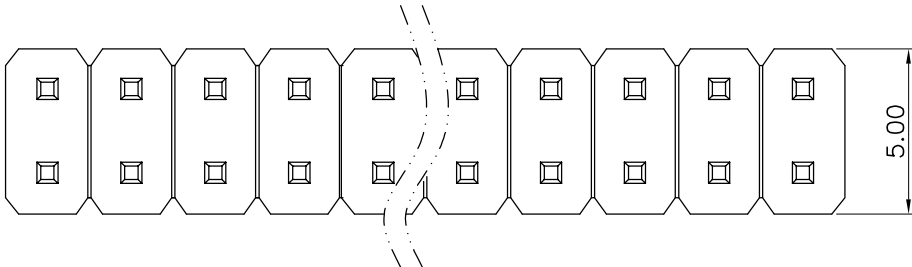
D

E

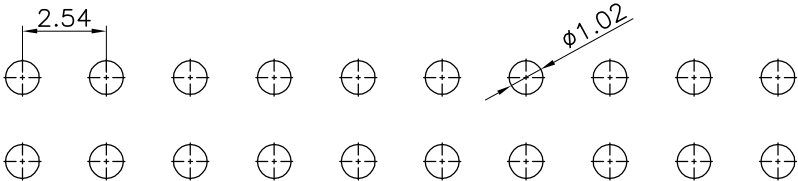
F

G

H



NOTE:
1.MATERIAL SPECIFICATION:
1-1.HOUSING: PA9T,UL94V-0
1-2.CONTACTS: BRASS
2.PLATING SPECIFICATION:
2-1.CONTACTS:
GOLD FLASH OVER NICKEL
3.ELECTRICAL PERFORMANCE:
3-1.CURRENT RATING: 3A
3-2.CONTACT RESISTANCE: 30 mΩ MAX
3-3.INSULATION RESISTANCE: 1000MΩ Min
3-4.DIELECTRIC WITHSTANDING : 500V
4.ENVIRONMENTAL PERFORMANCE:
4-1.OPERATING TEMPERATURE: -40°C~+105°C.
5.PACKAGE SPEC: PE BAG
6.P/N:
PH2541 25 M 0-2 XX 1 X X X 16
SERIES NO: _____
HEIGHT: _____
25-2.5mm
MALE FEMALE: _____
M-MALE
ANGLE: _____
0-180°
ROW NO: _____
2-DOUBLE ROW
PIN Q'PY: _____
02~40
HOUSING:
1-PA9T
COLOR:
A-BLACK
PLATING:
A-ALL AU G/F
TERMIPOINT:
1-DIP



Recommended PCB Layout
TOLERANCE:±0.05

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE:	NAME	DATE	PART.NO:	DWG.NO:		
AO	NEW RELEASE	21.10.15		LINEAR	ANGLES	1:1			PH254125M0-2XX1XXX16	ENDE05		
				0.0±0.35	X'REF±6°	APPROVED	Wang_jr	21.10.15	TITLE: Pitch 2.54mm 180° 双排 DIP 单塑排针 L=9.1mm(3.6/3.0)		REV: A0 SHEET: 1/1	
				0.00±0.25	X'±3°	DESIGNER	Gao_Han	21.10.15				
				0.000±0.10	X'X' ±2°	DRAWN	Gao_Han	21.10.15				